MOSFET – Single P-Channel, Small Signal, SOT-23

-8.0 V, -3.7 A

Features

- Leading Trench Technology for Low RDS(on)
- -1.8 V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint (3 x 3 mm)
- This is a Pb–Free Device

Applications

- High Side Load Switch
- DC–DC Conversion
- Cell Phone, Notebook, PDAs, etc.

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	-8.0	V
Gate-to-Source Voltage			V _{GS}	±8.0	V
Continuous Drain	$t \le 5 \text{ s}$ $T_A = 25^{\circ}C$		I _D	-3.7	А
Current (Note 1)	$T_A = 70^{\circ}C$			-3.0	
Power Dissipation (Note 1)	t≤5s		P _D	0.96	W
Pulsed Drain Current	t _p = 10 μs		I _{DM}	-11	А
Operating Junction and Storage Temperature			T _J , T _{STG}	–55 to 150	°C
Source Current (Body Diode)			I _S	-1.2	А
Lead Temperature for Sol (1/8" from case for 10		rposes	ΤL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State	$R_{\theta JA}$	160	°C/W
Junction-to-Ambient – t \leq 5 s	$R_{\theta JA}$	130	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface mounted on FR4 board using 1 in sq pad size

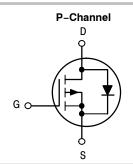
(Cu area = 1.127 in sq [1 oz] including traces).

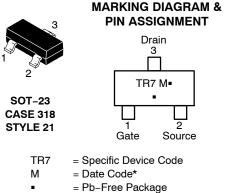


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V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max
	39 mΩ @ –4.5 V	
–8.0 V	52 mΩ @ –2.5 V	–3.7 A
	79 mΩ @ −1.8 V	





(Note: Microdot may be in either location) *Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTR2101PT1G	SOT-23 (Pb-Free)	3000/Tape & Reel

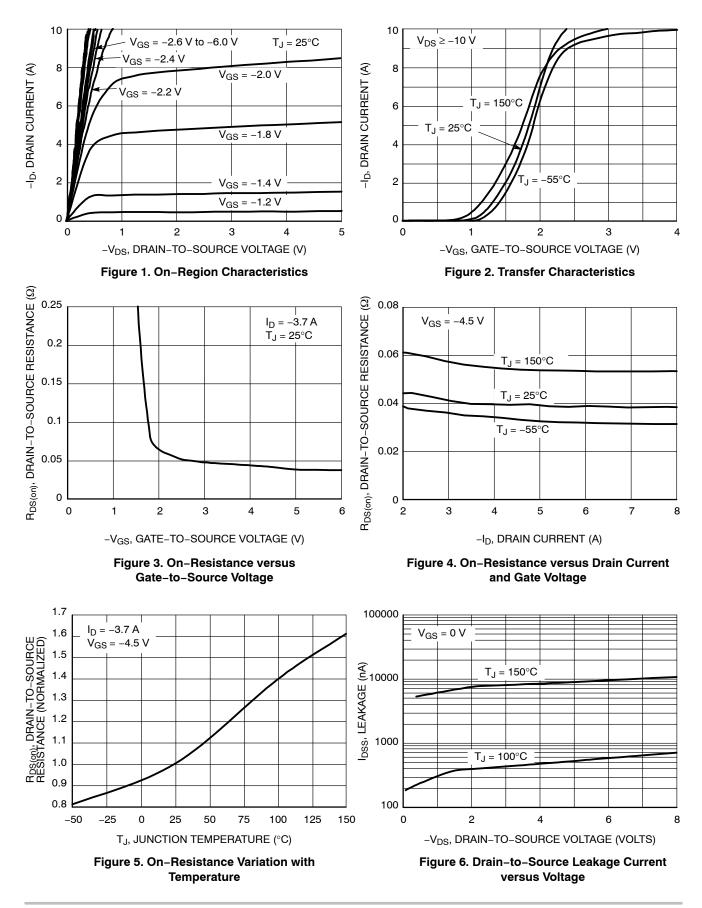
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise stated)

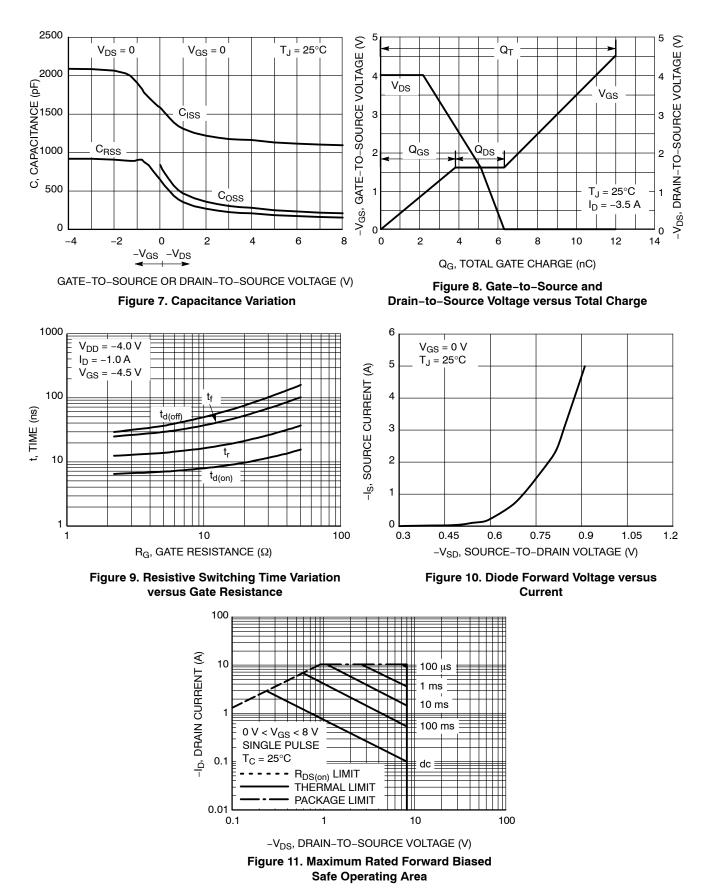
Parameter	Symbol	Test Cond	ition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D =	–250 μA	-8.0			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				10		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -6.4 V	$T_J = 25^{\circ}C$			-1.0	μΑ
		$V_{DS} = -6.4 V$	$T_J = 125^{\circ}C$			-100	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS}$				±100	nA
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	= –250 μA	-0.40		-1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				2.7		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = -4.5 V, I _I	₀ = -3.5 A		39	52	mΩ
		V _{GS} = -2.5 V, I _I	₀ = -3.0 A		52	72	
		V _{GS} = -1.8 V, I _I	₀ = -2.0 A		79	120	
Forward Transconductance	9 FS	$V_{GS} = -5.0$ V, I _I	₀ = -3.5 A		9.0		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				1173		pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = ⁻ V _{DS} = -4	I.0 MHz, .0 V		289		
Reverse Transfer Capacitance	C _{RSS}	. 53 .			218		
Total Gate Charge	Q _{G(TOT)}				12	15	nC
Gate-to-Source Charge	Q _{GS}	V _{GS} = -4.5 V, V _D I _D = -3.5	_S = -4.0 V, 5 A		3.8		
Gate-to-Drain Charge	Q _{GD}				2.5		
SWITCHING CHARACTERISTICS (Note 3	3)						
Turn-On Delay Time	t _{d(on)}	V_{GS} = -4.5 V, V_{DD} = -4.0 V, I_{D} = -1.2 A, R_{G} = 6.0 Ω			7.4	15	ns
Rise Time	t _r				15.75	25	
Turn-Off Delay Time	t _{d(off)}				38	58	
Fall Time	t _f				31	51	
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = -1.2 A	$T_J = 25^{\circ}C$		-0.73	-1.2	V

performance may not be indicated by the Electrical Characteristics for the listed test conditions. 2. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%. 3. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS

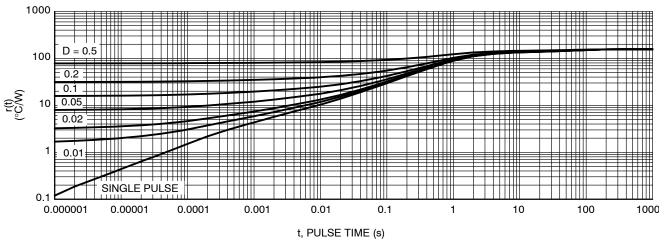


Figure 12. Thermal Response

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SOT-23 (TO-236) 2.90x1.30x1.00 1.90P **CASE 318**

ISSUE AU

DATE 14 AUG 2024













XXX = Specific Device Code М = Date Code

= Pb-Free Package .

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



MILLIMETERS						
DIM	MIN	NOM	МАХ			
А	0.89	1.00	1.11			
A1	0.01	0.06	0.10			
b	0.37	0.44	0.50			
с	0.08	0.14	0.20			
D	2.80	2.90	3.04			
E	1.20	1.30	1.40			
е	1.78	1.90	2.04			
L	0.30	0.43	0.55			
L1	0.35	0.54	0.69			
Ηe	2.10	2.40	2.64			
Т	0°		10°			

NOTES:

DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSIONS: 1.

2. MILLIMETERS.

MILLIME IERS. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE 3.

BASE MATERIAL. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, 4. PROTRUSIONS, OR GATE BURRS.

RECOMMENDED MOUNTING FOOTPRINT

* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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STYLE 1 THRU 5: CANCELLED	STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR	STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE	I	
STYLE 9:	STYLE 10:	STYLE 11:	STYLE 12:	STYLE 13:	STYLE 14:
PIN 1. ANODE	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. SOURCE	PIN 1. CATHODE
2. ANODE	2. SOURCE	2. CATHODE	2. CATHODE	2. DRAIN	2. GATE
3. CATHODE	3. GATE	3. CATHODE-ANODE	3. ANODE	3. GATE	3. ANODE
STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:	STYLE 19:	STYLE 20:
PIN 1. GATE	PIN 1. ANODE	PIN 1. NO CONNECTION	PIN 1. NO CONNECTION	I PIN 1. CATHODE	PIN 1. CATHODE
2. CATHODE	2. CATHODE	2. ANODE	2. CATHODE	2. ANODE	2. ANODE
3. ANODE	3. CATHODE	3. CATHODE	3. ANODE	3. CATHODE-ANODE	3. GATE
STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:	STYLE 25:	STYLE 26:
PIN 1. GATE	PIN 1. RETURN	PIN 1. ANODE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE
2. SOURCE	2. OUTPUT	2. ANODE	2. DRAIN	2. CATHODE	2. ANODE
3. DRAIN	3. INPUT	3. CATHODE	3. SOURCE	3. GATE	3. NO CONNECTION
STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE	STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE				

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